

**Product Manual** 

# DiamondMax 21 PATA

STM3320820A STM3300620A STM3250620A STM3250820A STM3200820A STM3160215A STM380215A

# **Revision status summary sheet**

Revision Date Sheets Affected Rev. A 11/16/06 Initial Release.

Rev. B 09/21/07 Front cover, 1, 3, 8-13, 16-18, 22 and 33.

Copyright © 2006, 2007 Seagate Technology LLC. All rights reserved. Printed in U.S.A.

Publication number: 100451230, Rev. B September 2007

Seagate, Seagate Technology and the Wave logo are registered trademarks of Seagate Technology LLC in the United States and/or other countries. DiamondMax, MaxBlast, Maxtor and the Maxtor logo are either trademarks or registered trademarks of Seagate Technology LLC or one of its affiliated companies in the United States and/or other countries. All other trademarks or registered trademarks are the property of their respective owners.

One gigabyte, or GB, equals one billion bytes when referring to hard drive capacity. Accessible capacity may vary depending on operating environment and formatting. Seagate reserves the right to change, without notice, product offerings or specifications.

# **Contents**

1.0	Introd	uction	. 1			
2.0	Drive	specifications	. 3			
	2.1	Specification summary tables	. :			
	2.2	Formatted capacity				
		2.2.1 LBA mode				
	2.3	Default logical geometry				
	2.4	Recording and interface technology				
	2.5	Physical characteristics				
	2.6	Seek time				
	2.7	Start/stop times				
	2.8	Power specifications				
	2.0	2.8.1 Power consumption				
		2.8.2 Conducted noise				
		2.8.3 Voltage tolerance				
		2.8.4 Power-management modes				
	2.9	Environmental specifications				
	2.0	2.9.1 Ambient temperature				
		2.9.2 Temperature gradient				
		2.9.3 Humidity				
		2.9.4 Altitude				
		2.9.5 Shock				
		2.9.6 Vibration				
	2.10	Acoustics				
	2.11	Electromagnetic immunity				
	2.12	Reliability				
		2.12.1 Annualized Failure Rate (AFR and Mean Time Between Failures (MTBF)				
	2.13	Agency certification				
		2.13.1 Safety certification				
		2.13.2 Electromagnetic compatibility.				
		2.13.3 FCC verification				
	2.14	Environmental protection				
		2.14.1 European Union Restriction of Hazardous Substances (RoHS) Directive				
		2.14.2 China Restriction of Hazardous Substances (RoHS) Directive				
	2.15	Corrosive environment				
3.0		guring and mounting the drive				
3.0		, ,				
	3.1 3.2	Handling and static discharge precautions				
	3.2 3.3	Breather filter hole precautions				
	3.3	Jumper settings     3.3.1   Master/slave configuration				
		•				
		3.3.2 Cable-select option				
	3.4	Drive mounting				
	_	· ·				
4.0		interface				
	4.1	ATA interface signals and connector pins				
		4.1.1 Supported ATA commands				
		4.1.2 Identify Device command				
		4.1.3 Set Features command				
		4.1.4 S.M.A.R.T. commands	36			
5.0	Maxto	r support services	37			

# **List of Figures**

Figure 1.	Typical 5V startup and operation current profile	14
Figure 2.	Typical 12V startup and operation current profile	14
Figure 3.	Breather filter hole location	24
Figure 4.	Master/slave jumper settings	25
Figure 5.	Ultra ATA cable connectors	26
Figure 6.	Mounting dimensions	27
Figure 7.	I/O pins and supported ATA signals	29

# 1.0 Introduction

This manual describes the functional, mechanical and interface specifications for the following Maxtor® DiamondMax® 21 PATA model drives:

STM3320820A STM3250620A STM3200820A STM380215A

STM3300620A STM3250820A STM3160215A

These drives provide the following key features:

- 7,200-RPM spindle speed
- High instantaneous (burst) data transfer rates (up to 100 Mbytes per second) using Ultra DMA mode 5.
- Tunneling magnetoresistive (TMR) recording heads and EPRML technology, which provide the drives with increased areal density.
- State-of-the-art cache and on-the-fly error-correction algorithms.
- Full-track multiple-sector transfer capability without local processor intervention.
- Quiet operation.
- SeaTools diagnostic software performs a drive self-test that eliminates unnecessary drive returns.
- Support for S.M.A.R.T. drive monitoring and reporting.
- · Support for Read Multiple and Write Multiple commands.
- · Support for autodetection of master/slave drives that use cable select (CSEL).

# 2.0 Drive specifications

Unless otherwise noted, all specifications are measured under ambient conditions, at 25°C, and nominal power. For convenience, the phrases *the drive* and *this drive* are used throughout this manual to indicate the following drive models:

STM3320820A STM3250620A STM3200820A STM380215A

STM3300620A STM3250820A STM3160215A

# 2.1 Specification summary tables

The specifications listed in the following tables are for quick reference. For details on specification measurement or definition, see the appropriate section of this manual.

Table 1: Drive specifications summary for the 320 and 300 Gbyte models

Drive specification	STM3320820A	STM3300620A	
Formatted Gbytes (512 bytes/sector)*	320	300	
Guaranteed sectors	625,142,448	586,072,368	
Heads	4	3	
Discs	2		
Bytes per sector	512		
Default sectors per track	63		
Default read/write heads	16		
Default cylinders	16,383		
Recording density	781 kbits/in max		
Track density	145 ktrakcs/in avg.		
Areal density	114.4 Gbits/in <sup>2</sup> avg		
Spindle speed	7,200 RPM		
Internal data transfer rate	1,030 Mbits/sec max		
Sustained data transfer rate	72 Mbytes/sec max		
I/O data-transfer rate	100 Mbytes/sec max		
ATA data-transfer modes supported	PIO modes 0–4 Multiword DMA modes 0–2 Ultra DMA modes 0–5		
Cache buffer	8 Mbytes	16 Mbytes	
Height (max)	26.1 mm (1.028 inches)	•	
Width (max)	101.6 mm (4.000 inches) +/- 0.010 inches		
Length (max)	146.99 mm (5.787 inches)		
Weight	635 grams	600 grams	
Average latency	4.16 msec		
Power-on to ready (max)	15 sec	11 sec	
Standby to ready (max)	15 sec		
Track-to-track seek time (typical)	<0.8 msec (read), <1.0 msec (write)		
Average seek, read (typical)	<11.0 msec		
Average seek, write (typical)	<12.0 msec		
Startup current (typical) 12V (peak)	2.8 amps		
Voltage tolerance (including noise)	5V ± 5% 12V ± 10%		
Ambient temperature	0° to 60°C (operating) -40° to 70°C (nonoperating)		
Temperature gradient	20°C per hour max (operating) 30°C per hour max (nonoperating)		
Relative humidity	5% to 90% (operating) 5% to 95% (nonoperating)		
Relative humidity gradient	30% per hour max		
Wet bulb temperature (max)	37.7°C (operating) 37.7°C (nonoperating)		
Altitude, operating	-60.96 m to 3,048 m (-200 ft. to 10,000+ ft.)		
Altitude, nonoperating (below mean sea level, max)	-60.96 m to 12,192 m (-200 ft. to 40,000+ ft.)		
Operational Shock	68 G at 2 msec		
Non-Operational Shock	350 G at 2 msec		

Drive specification	STM3320820A STM3300620A			
Vibration, operating	5–22 Hz: 0.25 G, Limited displacement 22–350 Hz: 0.50 G 350–500 Hz:: 0.25 G			
Vibration, nonoperating	5–22 Hz: 0.25 G, Limited displacement 22–350 Hz: 5.0 G 350–500 Hz:: 1.0 G			
Drive acoustics, sound power (Bels)				
Idle**	2.7 (typical) 3.0 (max)	2.5 (typical) 2.8 (max)		
Quiet seek	3.0 (typical) 3.4 (max)	3.0 (typical) 3.1 (max)		
Nonrecoverable read errors	1 per 10 <sup>14</sup> bits read			
Annualized Failure Rate (AFR)	0.34%			
Warranty	3 years on distribution units. To determine the warranty for a specific drive, use a web browser to access the follow web page: <a href="http://www.seagate.com/support/service/">http://www.seagate.com/support/service/</a> From this page, click on the "Verify Your Warranty" link. You will be asked to provide drive serial number, model number (or part number) and country of purchase. The stem will display the warranty information for your drive.			
Contact start-stop cycles	50,000 at 25°C, 50% rel. humidity			

<sup>\*</sup>One Gbyte equals one billion bytes when referring to hard drive capacity. Accessible capacity may vary depending on operating environment and formatting.

<sup>\*\*</sup>During periods of drive idle, some offline activity may occur according to the S.M.A.R.T. specification, which may increase acoustic and power to operational levels.

Table 2: Drive specifications summary for 250 and 200 Gbyte models

Drive specification	STM3250620A	STM3250820A	STM3200820A
Formatted Gbytes (512 bytes/sector)*	250		200
Guaranteed sectors	488,397,168		390,721,968
Heads	3		
Discs	2		
Bytes per sector	512		
Default sectors per track	63		
Default read/write heads	16		
Default cylinders	16,383		
Recording density	813 kbits/in max		781 kbits/in max
Track density	145 ktracks/in avg.		
Areal density	114.4 Gbits/in <sup>2</sup> avg		
Spindle speed	7,200 RPM		
Internal data transfer rate	1,030 Mbits/sec max		
Sustained data transfer rate OD	72 Mbytes/sec max		
I/O data-transfer rate	100 Mbytes/sec max		
ATA data-transfer modes supported	PIO modes 0–4 Multiword DMA modes 0–2 Ultra DMA modes 0–5		
Cache buffer	16 Mbytes	8 Mbytes	
Height (max)	26.1 mm (1.028 inches)		
Width (max)	101.6 mm (4.000 inches) +/-	0.010 inches	
Length (max)	146.99 mm (5.787 inches)		
Weight (max)	600 grams		
Average latency	4.16 msec		
Power-on to ready (max)	11 sec		
Standby to ready (max)	15 sec		
Track-to-track seek time (typical)	<0.8 msec (read), <1.0 mse	c (write)	
Average seek, read (typical)	<11.0 msec		
Average seek, write (typical)	<12.0 msec		
Startup current (typical) 12V (peak)	2.8 amps		
Voltage tolerance (including noise)	5V ± 5% 12V ± 10%		
Ambient temperature	0° to 60°C (operating) -40° to 70°C (nonoperating)		
Temperature gradient	20°C per hour max (operatin 30°C per hour max (nonoper		
Relative humidity	5% to 90% (operating) 5% to 95% (nonoperating)		
Relative humidity gradient	30% per hour max		
Wet bulb temperature	37.7°C max (operating) 37.7°C max (nonoperating)		
Altitude, operating	-60.96 m to 3,048 m (-200 ft. to 10,000+ ft.)		
Altitude, nonoperating (below mean sea level, max)	-60.96 m to 12,192 m (-200 ft. to 40,000+ ft.)		
Operational Shock	68 G at 2 msec		
Non-Operational Shock	350 G at 2 msec		

Drive specification	STM3250620A	STM3250820A	STM3200820A			
Vibration, operating	5–22 Hz: 0.25 G, Limited dis 22–350 Hz: 0.50 G 350–500 Hz:: 0.25 G	*****				
Vibration, nonoperating	5–22 Hz: 0.25 G, Limited dis 22–350 Hz: 5.0 G 350–500 Hz:: 1.0 G	== *** :=: *** *				
Drive acoustics, sound power (Bels)						
Idle**	2.5 (typical) 2.8 (max)					
Quiet seek	3.0 (typical) 3.1 (max)					
Nonrecoverable read errors	1 per 10 <sup>14</sup> bits read					
Annualized Failure Rate (AFR)	0.34%					
Warranty	3 years on distribution units. To determine the warranty for a specific drive, use a web browser to access the foll web page: <a href="http://www.seagate.com/support/service/">http://www.seagate.com/support/service/</a> From this page, click on the "Verify Your Warranty" link. You will be asked to provid drive serial number, model number (or part number) and country of purchase. The tem will display the warranty information for your drive.					
Contact start-stop cycles	50,000 at 25°C, 50% rel. hu	midity				

<sup>\*</sup>One Gbyte equals one billion bytes when referring to hard drive capacity. Accessible capacity may vary depending on operating environment and formatting.

<sup>\*\*</sup>During periods of drive idle, some offline activity may occur according to the S.M.A.R.T. specification, which may increase acoustic and power to operational levels.

Table 3: Drive specifications summary for the 160 and 80 Gbyte model

Drive specification	STM3160215A	STM380215A	
Formatted Gbytes (512 bytes/sector)*	160	80	
Guaranteed sectors	312,581,808	156,301,488	
Heads	2	1	
Discs	1		
Bytes per sector	512		
Default sectors per track	63		
Default read/write heads	16		
Default cylinders	16,383		
Recording density	824 kbits/in max		
Track density	137.259 ktracks/in avg.		
Areal density	101 Gbits/in <sup>2</sup> avg		
Spindle speed	7,200 RPM		
Internal data transfer rate	930 Mbits/sec max		
Sustained data transfer rate OD	78 Mbytes/sec max		
I/O data-transfer rate	100 Mbytes/sec max		
ATA data-transfer modes supported	PIO modes 0–4 Multiword DMA modes 0–2 Ultra DMA modes 0–5		
Cache buffer	2 Mbytes		
Height (max)	19.99 mm (0.787 inches)		
Width (max)	101.6 mm (4.000 inches) +/- 0.010 inches		
Length (max)	146.99 mm (5.787 inches)		
Weight (max)	380 grams	365 grams	
Average latency	4.16 msec		
Power-on to ready (max)	7.9 sec		
Standby to ready (max)	7.9 sec		
Track-to-track seek time (typical)	<1.0 msec (read), <1.2 msec (write)		
Average seek, read (typical)	<11.0 msec		
Average seek, write (typical)	<12.0 msec		
Startup current (typical) 12V (peak)	2.8 amps		
Voltage tolerance (including noise)	5V ± 5% 12V ± 10%		
Ambient temperature	0° to 60°C (operating) -40° to 70°C (nonoperating)		
Temperature gradient	20°C per hour max (operating) 30°C per hour max (nonoperating)		
Relative humidity	5% to 90% (operating) 5% to 95% (nonoperating)		
Relative humidity gradient	30% per hour max		
Wet bulb temperature	37.7°C max) (operating) 40.0°C max) (nonoperating)		
Altitude, operating	-60.96 m to 3,048 m (-200 ft. to 10,000+ ft.)		
Altitude, nonoperating (below mean sea level, max)	-60.96 m to 12,192 m (-200 ft. to 40,000+ ft.)		
Operational Shock	63 G max at 2 msec		
Non-Operational Shock	350 G max at 2 msec		

Drive specification	STM3160215A STM380215A		
Vibration, operating	5–22 Hz: 0.25 G, Limited displacement 22–350 Hz: 0.50 G 350–500 Hz:: 0.25 G		
Vibration, nonoperating	5–22 Hz: 0.25 G, Limited displacement 22–350 Hz: 5.0 G 350–500 Hz:: 1.0 G		
Drive acoustics, sound power (Bels)			
Idle**	2.8 (typical) 3.0 (max)		
Quiet seek	3.0 (typical) 3.2 (max)		
Nonrecoverable read errors	1 per 10 <sup>14</sup> bits read		
Annualized Failure Rate (AFR)	0.34%		
Warranty	3 years on distribution units. To determine the warranty for a specific drive, use a web browser to access the web page: <a href="http://www.seagate.com/support/service/">http://www.seagate.com/support/service/</a> From this page, click on the "Verify Your Warranty" link. You will be asked to prodrive serial number, model number (or part number) and country of purchase. It tem will display the warranty information for your drive.		
Contact start-stop cycles 50,000 at 25°C, 50% rel. humidity			

<sup>\*</sup>One Gbyte equals one billion bytes when referring to hard drive capacity. Accessible capacity may vary depending on operating environment and formatting.

<sup>\*\*</sup>During periods of drive idle, some offline activity may occur according to the S.M.A.R.T. specification, which may increase acoustic and power to operational levels.

# 2.2 Formatted capacity

Model	Formatted capacity*	Guaranteed sectors	Bytes per sector
STM3320820A	320 Gbytes	625,142,448	
STM3300620A	300 Gbytes	586,072,368	
STM3250620A	250 Chytos	488,397,168	
STM3250820A	- 250 Gbytes	400,397,100	512
STM3200820A	200 Gbytes	390,721,968	
STM3160215A	160 Gbytes	312,581,808	
STM380215A	80 Gbytes	156,301,488	

<sup>\*</sup>One Gbyte equals one billion bytes when referring to hard drive capacity. Accessible capacity may vary depending on operating environment and formatting.

## 2.2.1 LBA mode

When addressing these drives in LBA mode, all blocks (sectors) are consecutively numbered from 0 to n–1, where n is the number of guaranteed sectors as defined above.

See Section 4.1.2, "Identify Device command" (words 60-61 and 100-103) for additional information about 48-bit addressing support of drives with capacities over 137 Gbytes.

# 2.3 Default logical geometry

Cylinders	Read/write heads	Sectors per track
16,383	16	63

# 2.4 Recording and interface technology

	320GB	300GB	250GB	200GB	160GB	80GB
Interface	ATA					
Recording method	Perpendi	cular				
Recording density, KBPI (kbits/inch max)	781		813	781	824	
Track density, KTPI (ktracks/inch avg)	145			137.259		
Areal density (Gbits/inch <sup>2</sup> avg)	114.4			101		
Spindle speed (RPM) (± 0.2%) 7,200						
Internal data transfer rate (Mbits/sec max)	1,030			930		
Sustained data transfer rate (Mbytes/sec max)	72				78	
I/O data-transfer rate (Mbytes/sec max)	100 (Ultra	a DMA mode	e 5)			

# 2.5 Physical characteristics

Maximum height (320 - 200 Gbytes models)	26.1 mm (1.028 inches)
Maximum height (160 - 80 Gbyte models)	19.99 mm (0.787 inches)
Maximum width	101.6 mm (4.000 +/- 0.010 inches)
Maximum length	146.99 mm (5.787 inches)
Typical weight	
320GB model	635 grams (1.4 lbs)
300GB, 250GB and 200GB models	600 grams (1.32 lbs)
160GB model	380 grams (0.838 lbs)
80GB model	365 grams (0.805 lbs)
Cache Size	
STM3300620A and STM3250620A	16 Mbytes
STM3320820A, STM3250820A and STM3200820A	8 Mbyte
STM3160215A and STM380215A	2 Mbytes

## 2.6 Seek time

Seek measurements are taken with nominal power at 25°C ambient temperature. All times are measured using drive diagnostics. The specifications in the table below are defined as follows:

- Track-to-track seek time is an average of all possible single-track seeks in both directions.
- Average seek time is a true statistical random average of at least 5,000 measurements of seeks between random tracks, less overhead.

	320 - 200GB models		160 - 80GB models	
*Typical seek times (msec)	Read	Write	Read	Write
Track-to-track	<0.8	<1.0	<1.0	<1.2
Average	<11.0	<12.0	<11.0	<12.0
Average latency:	4.16			

<sup>\*</sup>Measured in quiet mode

**Note.** These drives are designed to consistently meet the seek times represented in this manual. Physical seeks, regardless of mode (such as track-to-track and average), are expected to meet or exceed the noted values. However, due to the manner in which these drives are formatted, benchmark tests that include command overhead or measure logical seeks may produce results that vary from these specifications.

# 2.7 Start/stop times

	320GB model	300 - 200GB model	160 - 80GB model
Power-on to Ready (sec)	15 (max)	11 (max)	7.9 (max)
Standby to Ready (sec)	15 (max)		7.9 (max)
Ready to spindle stop (sec)	dy to spindle stop (sec) 10 (max)		

# 2.8 Power specifications

The drive receives DC power (+5V or +12V) through a four-pin standard drive power connector.

#### 2.8.1 Power consumption

Power requirements for the drives are listed in the table on page 13. Typical power measurements are based on an average of drives tested, under nominal conditions, using +5.0V and +12.0V input voltage at 25°C ambient temperature.

#### · Spinup power

Spinup power is measured from the time of power-on to the time that the drive spindle reaches operating speed.

#### · Seek mode

During seek mode, the read/write actuator arm moves toward a specific position on the disc surface and does not execute a read or write operation. Servo electronics are active. Seek mode power represents the worst-case power consumption, using only random seeks with read or write latency time. This mode is not typical and is provided for worst-case information.

### · Read/write power and current

Read/write power is measured with the heads on track, based on a 16-sector write followed by a 32-msec delay, then a 16-sector read followed by a 32-msec delay.

#### Operating power and current

Operating power is measured using 40 percent random seeks, 40 percent read/write mode (1 write for each 10 reads) and 20 percent drive idle mode.

#### Idle mode power

Idle mode power is measured with the drive up to speed, with servo electronics active and with the heads in a random track location.

# · Standby mode

During Standby mode, the drive accepts commands, but the drive is not spinning, and the servo and read/write electronics are in power-down mode.

Table 4: DC power requirements (TBD) (values taken from DM21 SATA specs)

Power dissipation	Avg (watts 25° C)	Avg 5V typ amps	Avg 12V typ amps
Spinup	_	_	2.8 (peak)
Idle*	9.30	0.611	0.520
Seeking (random, 20% idle)	12.60	0.613	0.795
Standby and Sleep	0.80	0.106	0.023

<sup>\*</sup>During periods of drive idle, some offline activity may occur according to the S.M.A.R.T. specification, which may increase acoustic and power to operational levels.

# 2.8.1.1 Typical current profile

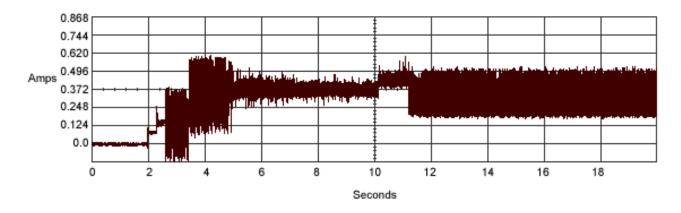


Figure 1 Typical 5V startup and operation current profile

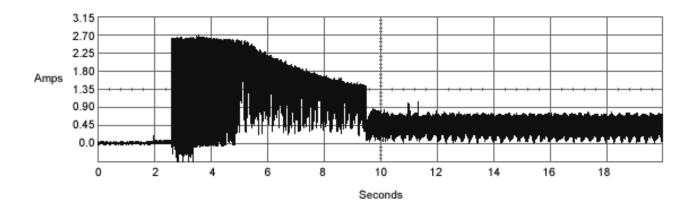


Figure 2 Typical 12V startup and operation current profile

#### 2.8.2 Conducted noise

Input noise ripple is measured at the host system power supply across an equivalent 80-ohm resistive load on the +12 volt line or an equivalent 15-ohm resistive load on the +5 volt line.

- Using 12-volt power, the drive is expected to operate with a maximum of 120 mV peak-to-peak square-wave injected noise at up to 10 MHz.
- Using 5-volt power, the drive is expected to operate with a maximum of 100 mV peak-to-peak square-wave injected noise at up to 10 MHz.

**Note.** Equivalent resistance is calculated by dividing the nominal voltage by the typical RMS read/write current.

### 2.8.3 Voltage tolerance

Voltage tolerance (including noise):

5V ± 5% 12V ± 10%

## 2.8.4 Power-management modes

The drive provides programmable power management to provide greater energy efficiency. In most systems, you can control power management through the system setup program. The drive features the following power-management modes:

Power mode	Heads	Spindle	Buffer
Active	Tracking	Rotating	Enabled
Idle	Tracking	Rotating	Enabled
Standby	Parked	Stopped	Enabled
Sleep	Parked	Stopped	Disabled

#### Active mode

The drive is in Active mode during the read/write and seek operations.

#### Idle mode

The buffer remains enabled, and the drive accepts all commands and returns to Active mode any time disc access is necessary.

#### · Standby mode

The drive enters Standby mode when the host sends a Standby Immediate command. If the host has set the standby timer, the drive can also enter Standby mode automatically after the drive has been inactive for a specifiable length of time. The standby timer delay is established using a Standby or Idle command. In Standby mode, the drive buffer is enabled, the heads are parked and the spindle is at rest. The drive accepts all commands and returns to Active mode any time disc access is necessary.

#### Sleep mode

The drive enters Sleep mode after receiving a Sleep command from the host. In Sleep mode, the drive buffer is disabled, the heads are parked and the spindle is at rest. The drive leaves Sleep mode after it receives a Hard Reset or Soft Reset from the host. After receiving a reset, the drive exits Sleep mode and enters Standby mode with all current translation parameters intact.

#### · Idle and Standby timers

Each time the drive performs an Active function (read, write or seek), the standby timer is reinitialized and begins counting down from its specified delay times to zero. If the standby timer reaches zero before any drive activity is required, the drive makes a transition to Standby mode. In both Idle and Standby mode, the drive accepts all commands and returns to Active mode when disc access is necessary.

# 2.9 Environmental specifications

# 2.9.1 Ambient temperature

Ambient temperature is defined as the temperature of the environment immediately surrounding the drive. Actual drive case temperature should not exceed 69°C (156°F) within the operating ambient conditions. Recommended measurement locations are shown in See Figure 6 on page 27.

Above 1,000 feet (305 meters), the maximum temperature is derated linearly to  $112^{\circ}F$  (44°C) at 10,000 feet (3,048 meters).

Operating:	5° to 60°C (41° to 140°F)
Nonoperating:	-40° to 70°C (-40° to 158°F)

## 2.9.2 Temperature gradient

Operating:	20°C per hour (68°F per hour max), without condensation
Nonoperating:	30°C per hour (86°F per hour max)

# 2.9.3 Humidity

# 2.9.3.1 Relative humidity

Operating:	5% to 90% noncondensing (30% per hour max)
Nonoperating:	5% to 95% noncondensing (30% per hour max)

## 2.9.3.2 Wet bulb temperature

Operating:	37.7°C (99.9°F max)	
Nonoperating:	37.7°C (99.9°F max) 320 - 200GB models 40.0°C (104°F max) 160 - 80GB models	

#### 2.9.4 Altitude

Operating:	ting: -60.96 m to 3,048 m (-200 ft. to 10,000+ ft.)	
Nonoperating:	-60.96 m to 12,192 m (-200 ft. to 40,000+ ft.)	

#### 2.9.5 Shock

All shock specifications assume that the drive is mounted securely with the input shock applied at the drive mounting screws. Shock may be applied in the X, Y or Z axis.

## 2.9.5.1 Operating shock

#### 320GB - 200GB models

These drives comply with the performance levels specified in this document when subjected to a maximum operating shock of 68 Gs based on half-sine shock pulses of 2 msec. Shocks should not be repeated more than two times per second.

#### 160GB - 80GB models

These drives comply with the performance levels specified in this document when subjected to a maximum operating shock of 63 Gs based on half-sine shock pulses of 2 msec. Shocks should not be repeated more than two times per second.

#### 2.9.5.2 Nonoperating shock

The nonoperating shock level that the drive can experience without incurring physical damage or degradation in performance when subsequently put into operation is 350 Gs based on a nonrepetitive half-sine shock pulse of 2 msec duration.

#### 2.9.6 Vibration

All vibration specifications assume that the drive is mounted securely with the input vibration applied at the drive mounting screws. Vibration may be applied in the X, Y or Z axis.

#### 2.9.6.1 Operating vibration

The following table lists the maximum vibration levels that the drive may experience while meeting the performance standards specified in this document.

5–22 Hz	0.25 G (limited displacement)	
22–350 Hz	0.50 G	
350–500 Hz	0.25 G	

## 2.9.6.2 Nonoperating vibration

The following table lists the maximum nonoperating vibration that the drive may experience without incurring physical damage or degradation in performance when subsequently put into operation.

5–22 Hz	0.25 G (limited displacement)	
22–350 Hz	5.0 G	
350–500 Hz	1.0 G	

# 2.10 Acoustics

Drive acoustics are measured as overall A-weighted acoustic sound power levels (no pure tones). All measurements are consistent with ISO document 7779. Sound power measurements are taken under essentially free-field conditions over a reflecting plane. For all tests, the drive is oriented with the cover facing upward.

**Note.** For seek mode tests, the drive is placed in seek mode only. The number of seeks per second is defined by the following equation:

(Number of seeks per second = 0.4 / (average latency + average access time)

Table 5: Fluid Dynamic Bearing (FDB) motor acoustics

Acoustic mode		
	Idle*	Quiet seek
STM3320820A	2.7 Bels (typ) 3.0 Bels (max)	3.0 Bels (typ) 3.4 Bels (max)
STM3300620A STM3250620A STM3250820A STM3200820A	2.5 Bels (typ) 2.8 Bels (max)	3.0 Bels (typ) 3.1 Bels (max)
STM3160215A STM380215A	2.8 Bels (typ) 3.0 Bels (max)	3.0 Bels (typ) 3.2 Bels (max)

<sup>\*</sup>During periods of drive idle, some offline activity may occur according to the S.M.A.R.T. specification, which may increase acoustic and power to operational levels.

# 2.11 Electromagnetic immunity

When properly installed in a representative host system, the drive operates without errors or degradation in performance when subjected to the radio frequency (RF) environments defined in the following table:

Table 6: Radio frequency environments

Test	Description	Performance level	Reference standard
Electrostatic discharge	Contact, HCP, VCP: ± 4 kV; Air: ± 8 kV	В	EN 61000-4-2: 95
Radiated RF immunity	80 to 1,000 MHz, 3 V/m, 80% AM with 1 kHz sine 900 MHz, 3 V/m, 50% pulse modulation @ 200 Hz	A	EN 61000-4-3: 96 ENV 50204: 95
Electrical fast transient	± 1 kV on AC mains, ± 0.5 kV on external I/O	В	EN 61000-4-4: 95
Surge immunity	± 1 kV differential, ± 2 kV common, AC mains	В	EN 61000-4-5: 95
Conducted RF immunity	150 kHz to 80 MHz, 3 Vrms, 80% AM with 1 kHz sine	А	EN 61000-4-6: 97
Voltage dips, interrupts	0% open, 5 seconds 0% short, 5 seconds 40%, 0.10 seconds 70%, 0.01 seconds	C C C B	EN 61000-4-11: 94

## 2.12 Reliability

#### 2.12.1 Annualized Failure Rate (AFR and Mean Time Between Failures (MTBF)

The product shall achieve an Annualized Failure Rate (AFR) of 0.34% (MTBF of 0.7 million hours) when operated in an environment of ambient air temperatures of 25°C. Operation at temperatures outside the specifications in Section 2.9 may increase the product AFR (decrease MTBF). AFR and MTBF are population statistics that are not relevant to individual units.

AFR and MTBF specifications are based on the following assumptions for desktop personal computer environments:

- 2400 power-on-hours per year.
- 10,000 average motor start/stop cycles per year.
- Operations at nominal voltages.
- Temperatures outside the specifications in Section 2.9 may reduce the product reliability.
- Normal I/O duty cycle for desktop personal computers. Operation at excessive I/O duty cycle may degrade product reliability.

The desktop personal computer environment of oower-on-hours, temperature, and I/O duty cycle affect the product AFR and MTBF. The AFR and MTBF will be degraded if used in a enterprise application.

Nonrecoverable read errors	1 per 10 <sup>14</sup> bits read, max	
Annualized Failure Rate (AFR)	0.34% (nominal power, 25°C ambient temperature)	
Contact start-stop cycles	50,000 cycles (at nominal voltage and temperature, with 60 cycles per hour and a 50% duty cycle)	
Warranty	3 years on distribution units. To determine the warranty for a specific drive, use a web browser to access the following web page: <a href="http://www.seagate.com/support/service/">http://www.seagate.com/support/service/</a> From this page, click on the "Verify Your Warranty" link. You will be asked to provide the drive serial number, model number (or part number) and country of purchase. The system will display the warranty information for your drive.	
Preventive maintenance	None required.	

## 2.13 Agency certification

#### 2.13.1 Safety certification

The drives are recognized in accordance with UL 1950 and CSA C22.2 (950) and meet all applicable sections of IEC950 and EN 60950.

#### 2.13.2 Electromagnetic compatibility

Hard drives that display the CE mark comply with the European Union (EU) requirements specified in the Electromagnetic Compatibility Directive (89/336/EEC). Testing is performed to the levels specified by the product standards for Information Technology Equipment (ITE). Emission levels are defined by EN 55022, Class B and the immunity levels are defined by EN 55024.

Drives are tested in representative end-user systems. Although CE-marked Seagate drives comply with the directives when used in the test systems, we cannot guarantee that all systems will comply with the directives. The drive is designed for operation inside a properly designed enclosure, with properly shielded I/O cable (if necessary) and terminators on all unused I/O ports. Computer manufacturers and system integrators should confirm EMC compliance and provide CE marking for their products.

#### Korean RRL

If these drives have the Korea Ministry of Information and Communication (MIC) logo, they comply with paragraph 1 of Article 11 of the Electromagnetic Compatibility control Regulation and meet the Electromagnetic Compatibility (EMC) Framework requirements of the Radio Research Laboratory (RRL) Ministry of Information and Communication Republic of Korea.

These drives have been tested and comply with the Electromagnetic Interference/Electromagnetic Susceptibility (EMI/EMS) for Class B products. Drives are tested in a representative, end-user system by a Korean-recognized lab.

Family name: DiamondMaxCertificate number: Pending

#### Australian C-Tick (N176)

If these models have the C-Tick marking, they comply with the Australia/New Zealand Standard AS/NZS3548 1995 and meet the Electromagnetic Compatibility (EMC) Framework requirements of the Australian Communication Authority (ACA).

#### 2.13.3 FCC verification

These drives are intended to be contained solely within a personal computer or similar enclosure (not attached as an external device). As such, each drive is considered to be a subassembly even when it is individually marketed to the customer. As a subassembly, no Federal Communications Commission verification or certification of the device is required.

Seagate Technology LLC has tested this device in enclosures as described above to ensure that the total assembly (enclosure, disc drive, motherboard, power supply, etc.) does comply with the limits for a Class B computing device, pursuant to Subpart J, Part 15 of the FCC rules. Operation with noncertified assemblies is likely to result in interference to radio and television reception.

Radio and television interference. This equipment generates and uses radio frequency energy and if not installed and used in strict accordance with the manufacturer's instructions, may cause interference to radio and television reception.

This equipment is designed to provide reasonable protection against such interference in a residential installation. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause interference to radio or television, which can be determined by turning the equipment on and off, you are encouraged to try one or more of the following corrective measures:

- · Reorient the receiving antenna.
- Move the device to one side or the other of the radio or TV.
- · Move the device farther away from the radio or TV.
- Plug the computer into a different outlet so that the receiver and computer are on different branch outlets.

If necessary, you should consult your dealer or an experienced radio/television technician for additional suggestions. You may find helpful the following booklet prepared by the Federal Communications Commission: How to Identify and Resolve Radio-Television Interference Problems. This booklet is available from the Superintendent of Documents, U.S. Government Printing Office, Washington, DC 20402. Refer to publication number 004-000-00345-4.

# 2.14 Environmental protection

Seagate designs its products to meet environmental protection requirements worldwide, including regulations restricting certain chemical substances.

# 2.14.1 European Union Restriction of Hazardous Substances (RoHS) Directive

Seagate designs its products to meet environmental protection requirements worldwide, including regulations restricting certain chemical substances. A new law, the European Union Restriction of Hazardous Substances (RoHS) Directive, restricts the presence of chemical substances, including Lead, Cadmium, Mercury, Hexavalent Chromium, PBB and PBDE, in electronic products, effective July 2006. This drive is manufactured with components and materials that comply with the RoHS Directive.

#### 2.14.2 China Restriction of Hazardous Substances (RoHS) Directive

## 2.14.2 中国限制危险物品的指令

This product has an Environmental Protection Use Period (EPUP) of 20 years. The following table contains information mandated by China's "Marking Requirements for Control of Pollution Caused by Electronic Information Products" Standard.



该产品具有20年的环境保护使用周期 (EPUP)。 下表包含了中国 "电子产品所导致的污染的控制的记号要求"所指定的信息。

	Toxic or Hazardous Substances or Elements有毒有害物质或元素					
					D a babasa sa isa a ka si	D a babasa a sina a basil
				l	Polybrominated	Polybrominated
	Lead	Mercury	Cadmium	Chromium	Biphenyl	Diphenyl Ether
Name of Parts	铅	汞	畅	六价铬	多微联苯	多微二苯醚
部件名称	(Pb)	(Hg)	(Cd)	(Cr6+)	(PBB)	(PBDE)
PCBA	Х	0	0	0	0	0
HDA	Х	0	0	. 0	0	0

<sup>&</sup>quot;O" indicates the hazardous and toxic substance content of the part (at the homogenous material level) is lower than the threshold defined by the China RoHS MCV Standard.

#### 2.15 Corrosive environment

Seagate electronic drive components pass accelerated corrosion testing equivalent to 10 years exposure to light industrial environments containing sulfurous gases, chlorine and nitric oxide, classes G and H per ASTM B845. However, this accelerated testing cannot duplicate every potential application environment. Users should use caution exposing any electronic components to uncontrolled chemical pollutants and corrosive chemicals as electronic drive component reliability can be affected by the installation environment. The silver, copper, nickel and gold films used in Seagate products are especially sensitive to the presence of sulfide, chloride, and nitrate contaminants. Sulfur is found to be the most damaging. In addition, electronic components should never be exposed to condensing water on the surface of the printed circuit board assembly (PCBA) or exposed to an ambient relative humidity greater than 95%. Materials used in cabinet fabrication, such as vulcanized rubber, that can outgas corrosive compounds should be minimized or eliminated. The useful life of any electronic equipment may be extended by replacing materials near circuitry with sulfide-free alternatives.

<sup>&</sup>quot;O"表示该部件(于同类物品程度上)所含的危险和有毒物质低于中国RoHS MCV标准所定义的门槛值。

<sup>&</sup>quot;X" indicates the hazardous and toxic substance content of the part (at the homogenous material level) is over the threshold defined by the China RoHS MCV Standard.

<sup>&</sup>quot;X"表示该部件(于同类物品程度上)所含的危险和有毒物质超出中国RoHS MCV标准所定义的门槛值。

# 3.0 Configuring and mounting the drive

This section contains the specifications and instructions for configuring and mounting the drive.

# 3.1 Handling and static discharge precautions

After unpacking, and before installation, the drive may be exposed to potential handling and electrostatic discharge (ESD) hazards. Observe the following standard handling and static-discharge precautions:

#### Caution:

- Before handling the drive, put on a grounded wrist strap, or ground yourself frequently by touching the metal chassis of a computer that is plugged into a grounded outlet. Wear a grounded wrist strap throughout the entire installation procedure.
- · Handle the drive by its edges or frame only.
- The drive is extremely fragile—handle it with care. Do not press down on the drive top cover.
- Always rest the drive on a padded, antistatic surface until you mount it in the computer.
- Do not touch the connector pins or the printed circuit board.
- Do not remove the factory-installed labels from the drive or cover them with additional labels. Removal voids the warranty. Some factory-installed labels contain information needed to service the drive. Other labels are used to seal out dirt and contamination.

# 3.2 Breather filter hole precautions

This section contains information regarding the precautions which should be taken regarding the breather filter hole in Seagate hard disc drives. Proper precautions should be taken to ensure full functionality and prevent possible damage to the drive.

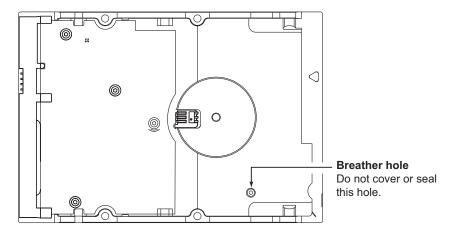


Figure 3 Breather filter hole location

Caution: Do not cover, seal, or insert any object into this hole.

This hole has two purposes:

- To allow condensation inside the hard disc to escape
- · To allow air pressure inside the hard disc to equalize with ambient pressure

**Note.** If this hole is covered, sealed, or penetrated by any object, the drive reliability may be compromised and could lead to permanent damage. Covering or sealing this hole voids the warranty.

# 3.3 Jumper settings

### 3.3.1 Master/slave configuration

The options jumper block shown in Figure 4 is used to configure the drive for operation. It is the 8-pin dual header between the interface connector and the power connector. Use the following settings to configure the drive as a master or a slave.

**Master or single drive.** The drive is configured at the factory for a master or single-drive operation with a jumper set on pins 7 and 8.

Drive as slave. Remove all jumpers.

## Drive as master with a non-ATA-compatible slave.

Use this jumper setting *only* if the drive does not work as a master with no jumpers installed.

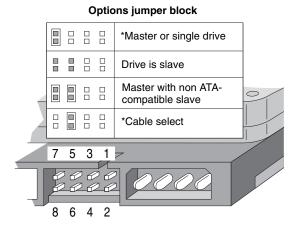


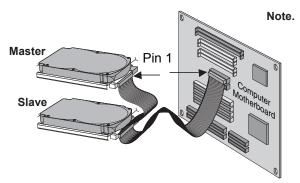
Figure 4 Master/slave jumper settings

## 3.3.2 Cable-select option

Computers that use cable select determine the master and slave drives by selecting or deselecting pin 28, CSEL, on the interface bus. Master and slave drives are determined by their physical position on the cable. To enable cable select, set a jumper on pins 5 and 6 as shown in Figure 4. Refer to your computer manual to determine whether your computer supports this option.

#### 3.3.3 Ultra ATA/100 cable

An 80-conductor 40-pin cable is required to run Ultra DMA mode 3, mode 4, and mode 5. This cable uses even-numbered conductors connected to the ground pins to improve signal integrity.



Note. If you are using a 40-pin, 80-conductor cable, attach the blue connector to the motherboard, the black connector to the master drive, and the gray connector to the slave.

Figure 5 Ultra ATA cable connectors

**Note.** The drive supports both host and drive cable detection. The host detects the 80-conductor cable by sampling pin 34, CBLID—, on the interface bus. The drive detects the 80-conductor cable by sensing a capacitor at the host side through the CBLID— signal. The result is reported in a Fast Rise Detected bit (bit 13 of word 93 in the Identify drive parameter block).

# 3.4 Drive mounting

You can mount the drive in any orientation using four screws in the side-mounting holes or four screws in the bottom-mounting holes. See Figure 6 for drive mounting dimensions. Follow these important mounting precautions when mounting the drive:

- Allow a minimum clearance of 0.030 inches (0.76 mm) around the entire perimeter of the drive for cooling.
- · Use only 6-32 UNC mounting screws.
- Do not overtighten the mounting screws (maximum torque: 6 inch-lb.).
- Do not use a drive interface cable that is more than 18 inches long.

#### Notes:

- 1. Dimensions are shown in inches (mm).
- 2 Dimensions per SFF-8301 specification.

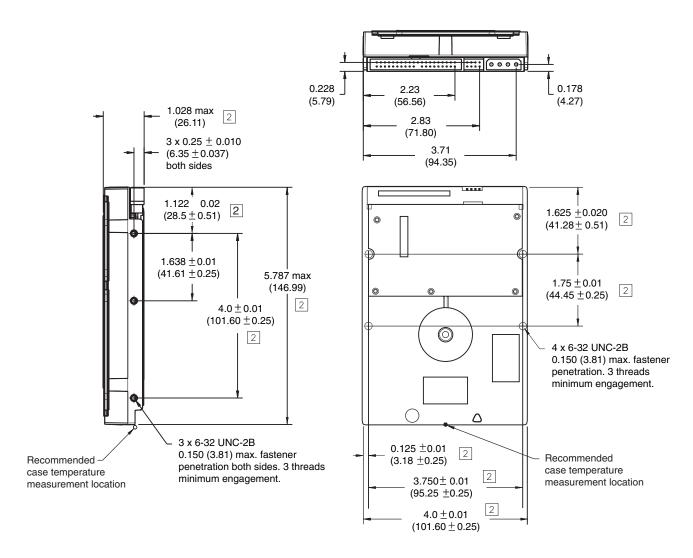


Figure 6 Mounting dimensions

# 4.0 ATA interface

These drives use the industry-standard ATA task file interface that supports 16-bit data transfers. It supports ATA programmed input/output (PIO) modes 0–4; multiword DMA modes 0–2, and Ultra DMA modes 0–5. The drive also supports the use of the IORDY signal to provide reliable high-speed data transfers.

You can use a daisy-chain cable to connect two drives to a single AT host bus. For detailed information about the ATA interface, refer to the draft of AT Attachment with Packet Interface Extension (ATA/ATAPI-7), NCITS T13 1410D, subsequently referred to as the Draft ATA-7 Standard.

# 4.1 ATA interface signals and connector pins

Figure 7 on page 29 summarizes the signals on the ATA interface connector that the drive supports. For a detailed description of these signals, refer to the *Draft ATA-7 Standard*.



Pins 26, 34 and 39 are used for master-slave communication (details shown below)



Figure 7 I/O pins and supported ATA signals

# 4.1.1 Supported ATA commands

The following table lists ATA-standard commands that the drive supports. For a detailed description of the ATA commands, refer to the *Draft ATA-7 Standard*. See "S.M.A.R.T. commands" on page 36 for details and subcommands used in the S.M.A.R.T. implementation.

Table 7: Supported ATA commands

Command name	Command code (in hex)
Check Power Mode	98 <sub>H</sub> or E5 <sub>H</sub>
Device Configuration Freeze Lock	B1 <sub>H</sub> / C1 <sub>H</sub>
Device Configuration Identify	B1 <sub>H</sub> / C2 <sub>H</sub>
Device Configuration Restore	B1 <sub>H</sub> / C0 <sub>H</sub>
Device Configuration Set	B1 <sub>H</sub> / C3 <sub>H</sub>
Device Reset	08 <sub>H</sub>
Download Microcode	92 <sub>H</sub>
Execute Device Diagnostics	90 <sub>H</sub>
Flush Cache	E7 <sub>H</sub>
Flush Cache Extended	EA <sub>H</sub>
Format Track	50 <sub>H</sub>
Identify Device	EC <sub>H</sub>
Idle	97 <sub>H</sub> or E3 <sub>H</sub>
Idle Immediate	95 <sub>H</sub> or E1 <sub>H</sub>
Initialize Device Parameters	91 <sub>H</sub>
Read Buffer	E4 <sub>H</sub>
Read DMA	C8 <sub>H</sub>
Read DMA Extended	25 <sub>H</sub>
Read DMA Without Retries	C9 <sub>H</sub>
Read Log Ext	2F <sub>H</sub>
Read Multiple	C4 <sub>H</sub>
Read Multiple Extended	29 <sub>H</sub>
Read Native Max Address	F8 <sub>H</sub>
Read Native Max Address Extended	27 <sub>H</sub>
Read Sectors	20 <sub>H</sub>
Read Sectors Extended	24 <sub>H</sub>
Read Sectors Without Retries	21 <sub>H</sub>
Read Verify Sectors	40 <sub>H</sub>
Read Verify Sectors Extended	42 <sub>H</sub>
Read Verify Sectors Without Retries	41 <sub>H</sub>
Recalibrate	10 <sub>H</sub>
Security Disable Password	F6 <sub>H</sub>
Security Erase Prepare	F3 <sub>H</sub>

Command name	Command code (in hex)
Security Erase Unit	F4 <sub>H</sub>
Security Freeze	F5 <sub>H</sub>
Security Set Password	F1 <sub>H</sub>
Security Unlock	F2 <sub>H</sub>
Seek	70 <sub>H</sub>
Set Features	EF <sub>H</sub>
Set Max Address	F9 <sub>H</sub>
Note: Individual Set Max Address commands are identified by the value placed in the Set Max Features register as defined to the right.	Address: 00 <sub>H</sub> Password: 01 <sub>H</sub> Lock: 02 <sub>H</sub> Unlock: 03 <sub>H</sub> Freeze Lock: 04 <sub>H</sub>
Set Max Address Extended	37 <sub>H</sub>
Set Multiple Mode	C6 <sub>H</sub>
Sleep	99 <sub>H</sub> or E6 <sub>H</sub>
S.M.A.R.T. Disable Operations	B0 <sub>H</sub> / D9 <sub>H</sub>
S.M.A.R.T. Enable/Disable Autosave	B0 <sub>H</sub> / D2 <sub>H</sub>
S.M.A.R.T. Enable Operations	B0 <sub>H</sub> / D8 <sub>H</sub>
S.M.A.R.T. Execute Offline	B0 <sub>H</sub> / D4 <sub>H</sub>
S.M.A.R.T. Read Attribute Thresholds	B0 <sub>H</sub> / D1 <sub>H</sub>
S.M.A.R.T. Read Data	B0 <sub>H</sub> / D0 <sub>H</sub>
S.M.A.R.T. Read Log Sector	B0 <sub>H</sub> / D5 <sub>H</sub>
S.M.A.R.T. Return Status	BO <sub>H</sub> / DA <sub>H</sub>
S.M.A.R.T. Save Attribute Values	B0 <sub>H</sub> / D3 <sub>H</sub>
S.M.A.R.T. Write Log Sector	B0 <sub>H</sub> / D6 <sub>H</sub>
Standby	96 <sub>H</sub> or E2 <sub>H</sub>
Standby Immediate	94 <sub>H</sub> or E0 <sub>H</sub>
Write Buffer	E8 <sub>H</sub>
Write DMA	CA <sub>H</sub>
Write DMA Extended	35 <sub>H</sub>
Write DMA Without Retries	CB <sub>H</sub>
Write Log Extended	3F <sub>H</sub>
Write Multiple	C5 <sub>H</sub>
Write Multiple Extended	39 <sub>H</sub>
Write Sectors	30 <sub>H</sub>
Write Sectors Without Retries	31 <sub>H</sub>
Write Sectors Extended	34 <sub>H</sub>

### 4.1.2 Identify Device command

The Identify Device command (command code  $EC_H$ ) transfers information about the drive to the host following power up. The data is organized as a single 512-byte block of data, whose contents are shown in the Table 7 on page 30. All reserved bits or words should be set to zero. Parameters listed with an "x" are drive-specific or vary with the state of the drive. See Section 2.0 on page 3 for default parameter settings.

The following commands contain drive-specific features that may not be included in the *Draft ATA-7 Standard*.

Word	Description	Value
0	Configuration information:  • Bit 15: 0 = ATA; 1 = ATAPI  • Bit 7: removable media  • Bit 6: removable controller  • Bit 0: reserved	0C5A <sub>H</sub>
1	Number of logical cylinders	16,383
2	ATA-reserved	0000 <sub>H</sub>
3	Number of logical heads	16
4	Retired	0000 <sub>H</sub>
5	Retired	0000 <sub>H</sub>
6	Number of logical sectors per logical track: 63	003F <sub>H</sub>
7–9	Retired	0000 <sub>H</sub>
10–19	Serial number: (20 ASCII characters, 0000 <sub>H</sub> = none)	ASCII
20	Retired	0000 <sub>H</sub>
21	Retired	0400 <sub>H</sub>
22	Obsolete	0000 <sub>H</sub>
23–26	Firmware revision (8 ASCII character string, padded with blanks to end of string)	x.xx
27–46	Drive model number (40 ASCII characters, padded with blanks to end of string)	MAXTOR STMxxxxxx
47	(Bits 7–0) Maximum sectors per interrupt on Read multiple and Write multiple (16)	8010 <sub>H</sub>
48	Reserved	0000 <sub>H</sub>
49	Standard Standby timer, IORDY supported and may be disabled	2F00 <sub>H</sub>
50	ATA-reserved	0000 <sub>H</sub>
51	PIO data-transfer cycle timing mode	0200 <sub>H</sub>
52	Retired	0200 <sub>H</sub>
53	Words 54–58, 64–70 and 88 are valid	0007 <sub>H</sub>
54	Number of current logical cylinders	xxxx <sub>H</sub>
55	Number of current logical heads	xxxx <sub>H</sub>
56	Number of current logical sectors per logical track	xxxx <sub>H</sub>
57–58	Current capacity in sectors	xxxx <sub>H</sub>
59	Number of sectors transferred during a Read Multiple or Write Multiple command	xxxx <sub>H</sub>

Word	Description	Value
60–61	Total number of user-addressable LBA sectors available (see Section 2.2 for related information)  *Note: The maximum value allowed in this field is: 0FFFFFFFh (268,435,455 sectors, 137 Gbytes). Drives with capacities over 137 Gbytes will have 0FFFFFFFh in this field and the actual number of user-addressable LBAs specified in words 100-103. This is required for drives that support the 48-bit addressing feature.	0FFFFFFFh*
62	Retired	0000 <sub>H</sub>
63	Multiword DMA active and modes supported (see note following this table)	<i>xx</i> 07 <sub>H</sub>
64	Advanced PIO modes supported (modes 3 and 4 supported)	0003 <sub>H</sub>
65	Minimum multiword DMA transfer cycle time per word (120 nsec)	0078 <sub>H</sub>
66	Recommended multiword DMA transfer cycle time per word (120 nsec)	0078 <sub>H</sub>
67	Minimum PIO cycle time without IORDY flow control (240 nsec)	00F0 <sub>H</sub>
68	Minimum PIO cycle time with IORDY flow control (120 nsec)	0078 <sub>H</sub>
69–74	ATA-reserved	0000 <sub>H</sub>
75	Queue depth	0000 <sub>H</sub>
76–79	SATA-specific	xxxx <sub>H</sub>
80	Major version number	007E <sub>H</sub>
81	Minor version number	0000 <sub>H</sub>
82	Command sets supported	346B <sub>H</sub>
83	Command sets supported	7D01 <sub>H</sub>
84	Command sets support extension	4003 <sub>H</sub>
85	Command sets enabled	34 <i>xx</i> <sub>H</sub>
86	Command sets enabled	3xxx <sub>H</sub>
87	Command sets enable extension	4003 <sub>H</sub>
88	Ultra DMA support and current mode (see note following this table)	xx3F <sub>H</sub>
89	Security erase time	0000 <sub>H</sub>
90	Enhanced security erase time	0000 <sub>H</sub>
92	Master password revision code	FFFE <sub>H</sub>
93	Hardware reset value (see description following this table)	xxxx <sub>H</sub>
95–99	ATA-reserved	0000 <sub>H</sub>
100–103	Total number of user-addressable LBA sectors available (see Section 2.2 for related information). These words are required for drives that support the 48-bit addressing feature. Maximum value: 0000FFFFFFFFFFF.	STM3320820A = 625,142,448 STM3300620A = 586,072,368 STM3250620A = 488,397,168 STM3250820A = 488,397,168 STM3200820A = 390,721,968 STM3160215A = 312,581.808 STM380215A = 156,301,488
104–127	ATA-reserved	0000 <sub>H</sub>
128	Security status	0001 <sub>H</sub>

Word	Description	Value
129–159	Seagate-reserved	ххххн
160–254	ATA-reserved	0000 <sub>H</sub>
255	Integrity word	xxA5 <sub>H</sub>

**Note.** Advanced Power Management (APM) and Automatic Acoustic Management (AAM) features are not supported

**Note.** See the bit descriptions below for words 63, 88, and 93 of the Identify Drive data:

Description (if bit is set to 1)			
Bit	Word 63		
0	Multiword DMA mode 0 is supported.		
1	Multiword DMA mode 1 is supported.		
2	Multiword DMA mode 2 is supported.		
8	Multiword DMA mode 0 is currently active.		
9	Multiword DMA mode 1 is currently active.		
10	Multiword DMA mode 2 is currently active.		
Bit	Word 88		
0	Ultra DMA mode 0 is supported.		
1	Ultra DMA mode 1 is supported.		
2	Ultra DMA mode 2 is supported.		
3	Ultra DMA mode 3 is supported.		
4	Ultra DMA mode 4 is supported.		
5	Ultra DMA mode 5 is supported.		
8	Ultra DMA mode 0 is currently active.		
9	Ultra DMA mode 1 is currently active.		
10	Ultra DMA mode 2 is currently active.		
11	Ultra DMA mode 3 is currently active.		
12	Ultra DMA mode 4 is currently active.		
13	Ultra DMA mode 5 is currently active.		
Bit	Word 93		
13	1 = 80-conductor cable detected, CBLID above V <sub>IH</sub> 0 = 40-conductor cable detected, CBLID below V <sub>IL</sub>		

### 4.1.3 Set Features command

This command controls the implementation of various features that the drive supports. When the drive receives this command, it sets BSY, checks the contents of the Features register, clears BSY and generates an interrupt. If the value in the register does not represent a feature that the drive supports, the command is aborted. Power-on default has the read look-ahead and write caching features enabled. The acceptable values for the Features register are defined as follows:

02 <sub>H</sub>	Enable write cache (default).					
03 <sub>H</sub>	Set transfer mode (based on value in Sector Count register).					
	Sector Count register values:					
	00 <sub>H</sub> Set PIO mode to default (PIO mode 2).					
	01 <sub>H</sub> Set PIO mode to default and disable IORDY (PIO mode 2).					
	08 <sub>H</sub> PIO mode 0					
	09 <sub>H</sub>	PIO mode 1				
	0A <sub>H</sub> PIO mode 2					
	0B <sub>H</sub> PIO mode 3					
	0C <sub>H</sub> PIO mode 4 (default)					
	20 <sub>H</sub>	Multiword DMA mode 0				
	21 <sub>H</sub>	Multiword DMA mode 1				
	22 <sub>H</sub>	Multiword DMA mode 2				
	40 <sub>H</sub>	Ultra DMA mode 0				
	41 <sub>H</sub>	Ultra DMA mode 1				
	42 <sub>H</sub>	Ultra DMA mode 2				
	43 <sub>H</sub>	Ultra DMA mode 3				
	44 <sub>H</sub>	Ultra DMA mode 4				
	45 <sub>H</sub>	Ultra DMA mode 5				
55 <sub>H</sub>	Disable read look-ahead (read cache) feature.					
82 <sub>H</sub>	Disable write cache.					
$AA_H$	Enable read look-ahead (read cache) feature (default).					
F1 <sub>H</sub>	Report full capacity available					

**Note.** At power-on, or after a hardware or software reset, the default values of the features are as indicated above.

### 4.1.4 S.M.A.R.T. commands

S.M.A.R.T. provides near-term failure prediction for disc drives. When S.M.A.R.T. is enabled, the drive monitors predetermined drive attributes that are susceptible to degradation over time. If self-monitoring determines that a failure is likely, S.M.A.R.T. makes a status report available to the host. Not all failures are predictable. S.M.A.R.T. predictability is limited to the attributes the drive can monitor. For more information on S.M.A.R.T. commands and implementation, see the *Draft ATA-7 Standard*.

SeaTools diagnostic software activates a built-in drive self-test (DST S.M.A.R.T. command for D4<sub>H</sub>) that eliminates unnecessary drive returns. The diagnostic software ships with all new drives and is also available at: <a href="http://seatools.seagate.com">http://seatools.seagate.com</a>.

This drive is shipped with S.M.A.R.T. features disabled. You must have a recent BIOS or software package that supports S.M.A.R.T. to enable this feature. The table below shows the S.M.A.R.T. command codes that the drive uses.

Code in features register	S.M.A.R.T. command
D0 <sub>H</sub>	S.M.A.R.T. Read Data
D2 <sub>H</sub>	S.M.A.R.T. Enable/Disable Attribute Autosave
D3 <sub>H</sub>	S.M.A.R.T. Save Attribute Values
D4 <sub>H</sub>	S.M.A.R.T. Execute Off-line Immediate (runs DST)
D5 <sub>H</sub>	S.M.A.R.T. Read Log Sector
D6 <sub>H</sub>	S.M.A.R.T. Write Log Sector
D8 <sub>H</sub>	S.M.A.R.T. Enable Operations
D9 <sub>H</sub>	S.M.A.R.T. Disable Operations
DA <sub>H</sub>	S.M.A.R.T. Return Status

**Note.** If an appropriate code is not written to the Features Register, the command is aborted and 0x04 (abort) is written to the Error register.

# 5.0 Maxtor support services

Before contacting Maxtor Support, use the Hard Disk Information feature in MaxBlast to view the model number and serial number of your drive. These numbers can be used to get help from Maxtor Support, register your drive, and look up information on the Maxtor website.

Please visit <a href="http://www.seagate.com/maxtor/">http://www.seagate.com/maxtor/</a> to obtain comprehensive support information, such as:

- Warranty services
   Drive returns, warranty status, and limited warranty statement.
- Product support Installation tutorials, specifications, jumper settings, installation guides, and product manuals.
- Software downloads Installation software, utilities, and diagnostics.
- Knowledge Base
   Troubleshooting information, FAQs, and resolved problem database.
- Product Index Current and legacy Maxtor products listing.

Click on Maxtor Product Support to access the Knowledge Base, download software updates, register your drive, and get assistance via e-mail

#### Index Device Configuration Identify 30 Device Configuration Restore 30 Device Configuration Set 30 Α Device Reset 30 diagnostic software 1, 36 acoustics 18 dissipation 13 Active mode 15 Download Microcode 30 AFR 20 drive diagnostics 12 agency certification (regulatory) 20 drive monitoring 1 altitude 16 drive self-test 1, 36 ambient conditions 3 DST 36 ambient temperature 12, 16 duty cycle 20 Annualized Failure Rate 20 Annualized Failure Rate (AFR) 20 E areal density 1, 11 ATA interface 29 electrical fast transient 19 ATA-standard commands 30 electromagnetic compatibility 20 Australian C-Tick 21 Electromagnetic Compatibility Directive 20 autodetection 1 electromagnetic immunity 19 average seek time 12 electrostatic discharge 19 EMC compliance 20 В EN 60950 20 enclosures 21 BPI 11 environmental specifications 16 breather filter hole precautions 24 EPRML 1, 11 burst 1 error-correction algorithms 1 errors 20 C EU RoHS directive 22 cable 26 European Union 20 cable select 1 Execute Device Diagnostics 30 cable-select option 25 cache 1 F case temperature 16 failure prediction 36 CE mark 20 FCC verification 21 certification 20 Features register 35 Check Power Mode 30 Flush Cache 30 China RoHS directive 22 Flush Cache Extended 30 commands 30 Format Track 30 conducted noise 14 formatted capacity 10 conducted RF immunity 19 frequency 19 configuring the drive 23 connector pins 29 G connectors 26 Corrosive environment 22 guaranteed sectors 10 CSA C22.2 (950) 20 CSEL 25 Н C-Tick 21 handling 23 current profile 14 heads 1 cycles 20 height 11 humidity 16 data-transfer rates 1 DC power 13 I/O data-transfer rate 11 density 11 I/O duty cycle 20

Identify Device 30

Device Configuration Freeze Lock 30

Identify Device command 32 Idle 30	P
Idle and Standby timers 15 Idle Immediate 30	physical characteristics 11 pins 29
Idle mode 15 Idle mode power 13	PIO 29 power consumption 13
IEC950 20	power dissipation 13 power management 15
Information Technology Equipment 20 Initialize Device Parameters 30	power specifications 13
interface 11, 29	power-management modes 15 Power-on to Ready 12
interface signals 29	power-on-hours 20
interference 21 internal data-transfer rate OD 11	precautions 26
ISO document 7779 18	programmable power management 15
J	R
jumper settings 25	radiated RF immunity 19 radio and television interference 21
K	radio frequency 19 random track location 13
Korean RRL 21	Read Buffer 30
L	Read DMA 30 Read DMA Extended 30
LBA mode 10	Read DMA without Retries 30
length 11	read errors 20
logical geometry 10	Read Log Ext 30  Read Multiple 1, 30
М	Read Multiple Extended 30
	Read Native Max Address 30
maintenance 20 master 25	Read Native Max Address Extended 30 Read Sectors 30
master/slave 1	Read Sectors Extended 30
Master/slave configuration 25	Read Sectors Without Retries 30
maximum temperature 16	Read Verify Sectors 30
Mean Time Between Failures 20 measurement locations 16	Read Verify Sectors Extended 30 Read Verify Sectors Without Retries 30
modes 29	read/write power and current 13
monitoring 1	Recalibrate 30
mounting the drive 23, 26	recording and interface technology 11
MTBF 20	recording density 11 recording heads 1
N	recording method 11
noise 14	register 35
nominal power 3	relative humidity 16
nonoperating shock 17	reliability 20 resistance 14
nonoperating vibration 17	resistive load 14
Nonrecoverable read errors 20	RF 19
0	RoHS 22
operating power and current 13 operating shock 17	S
operating shock 17 operating vibration 17	S.M.A.R.T. commands 36
orientation 26	S.M.A.R.T. Disable Operations 31 S.M.A.R.T. drive monitoring 1
	S.M.A.R.T. Grive monitoring T S.M.A.R.T. Enable/Disable Autosave 31

S.M.A.R.T. Enagle Operations 31 S.M.A.R.T. Execute Offline 31 S.M.A.R.T. Read Attribute Thresholds S.M.A.R.T. Read Data 31 S.M.A.R.T. Read Log Sector 31 S.M.A.R.T. Return Status 31 S.M.A.R.T. Save Attribute Values 31 S.M.A.R.T. Write Log sector 31 safety certification 20 screws 26 SeaTools 1, 36	31
sectors 10 Security Disable Password 30 Security Erase Prepare 30 Security Erase Unit 31	
Security Freeze 31 Security Set Password 31 Security Unlock 31 Seek 31	
seek mode 13 seek time 12	
Seeking 13 servo electronics 13 Set Features 31	
Set Features command 35 Set Max Address 31 Set Max Address Extended 31	
Set Multiple Mode 31 shock 17 signals 29	
single-track seeks 12 slave 25	
Sleep 13, 31 Sleep mode 15 sound 18	
specifications 3 spindle speed 11 Spinup 13	
spinup power 13 Standby 13, 31 Standby Immediate 31	
Standby mode 13, 15 Standby to Ready 12 start/stop times 12	
start-stop cycles 20 static-discharge precautions 23 stop times 12	
subassembly 21 support services 37 surge immunity 19	
T	
technical support services 37 temperature 16	

timers 15 TMR 1 track density 11 track-to-track seek time 12

### U

UL 1950 20 Ultra ATA/100 26 Ultra DMA 26

### V

vibration 17 voltage 14 voltage dips, interrupts 19 voltage tolerance 14

## W

Warranty 20
weight 11
wet bulb temperature 16
width 11
Write Buffer 31
Write DMA 31
Write DMA Extended 31
Write DMA Without Retries 31
Write Log Extended 31
Write Multiple 1, 31
Write Multiple Extended 31
Write Sectors 31
Write Sectors Extended 31
Write Sectors Without Retries 31

temperature gradient 16

